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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/885,527	06/21/2001	Jong-Woo Kim	053785-5018	2621

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EXAMINER

CHUNG, DAVID Y

ART UNIT PAPER NUMBER

2871

DATE MAILED: 02/26/2003

Please find below and/or attached an Office communication concerning this application or proceeding.

Offic Action Summary	Application N .	Applicant(s)
	09/885,527	KIM ET AL.
Examiner	Art Unit	
David Y. Chung	2871	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133).
- Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

1) Responsive to communication(s) filed on 28 January 2003.

2a) This action is **FINAL**. 2b) This action is non-final.

3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

4) Claim(s) 1-28 is/are pending in the application.

4a) Of the above claim(s) 18-28 is/are withdrawn from consideration.

5) Claim(s) _____ is/are allowed.

6) Claim(s) 1-17 is/are rejected.

7) Claim(s) _____ is/are objected to.

8) Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

9) The specification is objected to by the Examiner.

10) The drawing(s) filed on _____ is/are: a) accepted or b) objected to by the Examiner.

Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).

11) The proposed drawing correction filed on _____ is: a) approved b) disapproved by the Examiner.

If approved, corrected drawings are required in reply to this Office action.

12) The oath or declaration is objected to by the Examiner.

Priority under 35 U.S.C. §§ 119 and 120

13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).

a) All b) Some * c) None of:

1. Certified copies of the priority documents have been received.
2. Certified copies of the priority documents have been received in Application No. _____.
3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).

a) The translation of the foreign language provisional application has been received.

15) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.

Attachment(s)

1) Notice of References Cited (PTO-892)

2) Notice of Draftsperson's Patent Drawing Review (PTO-948)

3) Information Disclosure Statement(s) (PTO-1449) Paper No(s) _____.

4) Interview Summary (PTO-413) Paper No(s) _____.

5) Notice of Informal Patent Application (PTO-152)

6) Other: _____.

DETAILED ACTION

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1-17 rejected under 35 U.S.C. 103(a) as being over Park et al. (U.S. 6,335,276) in further view of Kim (U.S. 6,255,130) and Park et al. (U.S. 6,287,899).

As to claim 1, Park et al. (U.S. 6,335,276) discloses a method for manufacturing a thin film transistor array for a liquid crystal display and a photolithography method for fabricating thin films. Park et al. (U.S. 6,335,276) discloses the following steps: forming gate lines, gate electrodes, and gate pads on a substrate; depositing a gate insulating layer, semiconductor layer, ohmic contact layer, and conductor layer; patterning the conductor layer and ohmic contact layer to form data lines, source and data electrodes, and data pads; depositing a passivation layer; coating a photoresist on the passivation layer; exposing the photoresist to light through one or more masks having different transmittance between the display area and peripheral area to form a photoresist pattern having different thickness depending on the position. See abstract. Figure 11 shows a mask with light shielding portions, light transmissive portions and semi-

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transmissive portions. Figure 12A shows a photoresist pattern with varying thickness depending on position. Figure 19 shows the active matrix substrate after patterning the passivation layer, active layer and insulating layer and after forming the pixel electrode.

Kim (U.S. 6,255,130) discloses a storage capacitor formed in the middle of the pixel area with the pixel electrode contacting the storage capacitor electrode through contact holes in the insulation layer. See figures 1 and 2. Note pixel electrode 82, contact holes 74, and storage capacitor electrode 68. It would have been obvious to one of ordinary skill in the art at the time of invention to form the storage capacitor of Kim (U.S. 6,255,130) in the display of Park et al. (U.S. 6,335,276) because it is a functionally equivalent alternative to the storage capacitor disclosed by Park et al. (U.S. 6,335,276).

As to claim 2, figure 18 of Park et al. (U.S. 6,335,276) shows the gate lines arranged perpendicular to the data lines to form a matrix pattern with the source electrode spaced apart from drain electrode.

As to claim 3, Park et al. (U.S. 6,335,276) discloses depositing and patterning a first conductive layer to form gate wiring by dry or wet etch using a first photolithography step as shown in figures 6A to 6C. See column 10, lines 13 – 18.

As to claims 4 and 5, Park et al. (U.S. 6,335,276) discloses depositing a gate insulator layer, semiconductor layer, and second conductive layer and then patterning

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the second conductive layer to form data wiring and storage capacitor electrodes by a second photolithography step as shown in figures 7A and 7B. See column 10, lines 19 – 34.

As to claim 6, Park et al. (U.S. 6,335,276) discloses patterning the passivation layer, semiconductor layer, and gate insulator to form contact holes 71, 72, and 73 by a third photolithography step as shown in figures 8A, 13A and 13B. For this purpose, a photoresist pattern is formed to have thickness that varies depending on the location. See column 10, lines 35 – 53.

As to claim 7, Park et al. (U.S. 6,335,276) discloses data contact holes 73 and gate contact holes 72 formed in passivation layer 70. See figures 3 and 4.

Although Park et al. (U.S. 6,335,276) does not disclose exposing both a side portion and upper surface of the drain electrode, it was well known and obvious to do this in order to increase the contact area and form better electrical connection between the pixel electrode and drain electrode as shown in figure 15 of Park et al. (U.S. 6,287,889). Therefore, it would have been obvious to one of ordinary skill in the art at the time of invention to expose both a side portion and upper surface of the drain electrode in order to form better electrical contact with the pixel electrode.

As to claim 8, Park et al. (U.S. 6,335,276) teaches that it is preferable for the thin portions of the photoresist pattern to have a thickness in the range of 350 to 10,000 angstroms. See column 12, lines 21 – 23.

As to claim 9, Park et al. (U.S. 6,335,276) teaches that the gate wiring may have a multi-layered structure, in which case it is preferably made of one material having low resistivity and another material having good contact with other materials. Double layers of Cr/Al (or Al alloy) and Al/Mo are examples given by Park et al. (U.S. 6,335,276). See column 8, lines 31 – 38.

As to claims 10 and 11, Park et al. (U.S. 6,335,276) teaches that both the gate insulator 30 and passivation layer 70 can be made of inorganic material such as silicon nitride. See column 8, lines 39 – 40 and column 9, lines 45 – 50.

As to claims 12 and 13, Park et al. (U.S. 6,335,276) teaches that the passivation layer can be made of insulating material such as acrylic organic material. See column 9, lines 45 – 50.

As to claim 14, Park et al. (U.S. 6,335,276) does not disclose making the width of the passivation layer smaller than the width of the data line. However, Park et al. (U.S. 6,287,899) discloses a redundant data line overlapping and connecting to the primary data line through a contact hole. See figure 4. It was well known and obvious that

making the width of the passivation layer smaller than the width of the data line caused the side portions of the data line to be exposed. It was well known and obvious that exposing side portions of the data line increased contact area and improved the electrical connection to the data line. Therefore, it would have been obvious to one of ordinary skill in the art at the time of invention to make the width of the passivation layer smaller than the width of the data line in order to improve electrical connection between the primary data line and a redundant data line.

As to claims 15 and 16, Park et al. (U.S. 6,335,276) discloses in figure 11, a mask having pattern layer 520. This layer is the same as the opaque pattern layer 320 shown in figure 9A. This layer is made of such material as chromium. See column 11, lines 5 – 10 and 30 – 40.

As to claim 17, Park et al. (U.S. 6,335,276) does not disclose molybdenum silicide material for the transmittance control layer 550 in figure 11. However, molybdenum silicide was a common and conventional semi-transmissive material used in photomasks. It was well known and obvious for transmitting a suitably small percentage of light for most photolithography applications. This allowed the difference between light and dark areas on the photoresist to be accentuated properly. Therefore, it would have been obvious to one of ordinary skill in the art to form the transmittance control layer in the mask of Park et al. (U.S. 6,335,276) using molybdenum silicide in

- order to properly accentuate the difference between light and dark areas on the photoresist layer.

Response to Arguments

Applicant's arguments with respect to claim 1 have been considered but are moot in view of the new ground(s) of rejection. The additional limitation of amended claim 1 is not disclosed by the primary reference of Park et al. (U.S. 6,335,276) but is taught by secondary references Kim (U.S. 6,255,130) and Park et al. (U.S. 6,287,899).

Therefore, claim 1 is now rejected as being obvious over the combination of Park et al. (U.S. 6,335,276) in view of Kim (U.S. 6,255,130) and Park et al. (U.S. 6,287,899).

Conclusion

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to David Chung whose telephone number is (703) 306-0155. The examiner can normally be reached on Monday-Friday from 8:30 am to 5:00 pm.


DAVID M. CHUNG
SUPERVISOR EXAMINER
TUE 2/22/03

David Chung
GAU 2871
02/22/03